



# Carrier-Q7-D59

# Wide range of interfaces for broad development possibilities



### HIGHLIGHTS

- · 3.5" form factor carrier board for Qseven® modules
- Multiple video interfaces
- · Multiple connectivity options
- · Embedded industrial interfaces
- () Available in Industrial Temperature Range



# Information subject to change. Please visit www.edge.seco.com to find the latest version of this datasheet

### FEATURES

Video Interfaces	LVDS Single/Dual Channel 18-24-bit + HDMI® Connector <b>or</b> 2 x eDP connectors + Multimode Display Port
D Mass Storage	1 x SATA connector with HDD Power connector 1 x M.2 Socket 2 2242 Key B SSD Slot microSD Slot on combo microSD + SIM connector
문 Networking	Up to 2 x Gigabit Ethernet connectors 1 x M.2 Socket 2 2242/3042 Key B Slot for WWAN Modem Modules, connected to on-board miniSIM slot
•⇐ USB	2 x Superspeed USB 5Gbp Host port on Dual Type-A socket 1 x USB 2.0 Host ports on double Type-A sockets 1 x USB 2.0 Host on internal M.2 Socket 1 x USB 2.0 OTG port on micro-AB socket (USB port shared with USB 2.0 lanes of 1 x USB 3.0)
Audio	Audio interface on internal pin header
📼 Serial Ports	4-wire RS-232 / RS-422 / RS-485 configurable serial port on DB9 male connector 2 x RS-232 Full-modem serial ports on internal header (need LPC interface from Qseven® module) CAN interface on PCB terminal block
Other Interfaces	SPI internal pin header LPC Bus internal pin header SM Bus / I2C GPIO expander, makes available 16 x GPIOs on internal pin header Front Panel Header I x 28 pin connector for additional features (I2C, ACPI signals, SM Bus, Watch Dog, Thermal Management) +12V Tachometric FAN connector Optional Debug USB port on miniB socket Optional MFG connector for JTAG programming of Qseven® module

	Power Supply	24V <sub>DC</sub> ±5% through Micro-fit 2x2 power connector Coin cell battery Holder for CMOS and RTC
	Operating Temperature*	-40°C ÷ +85°C (Industrial temperature range)
L	Dimensions	146 x 102 mm (5.75" x 4.02")
* 4 11		

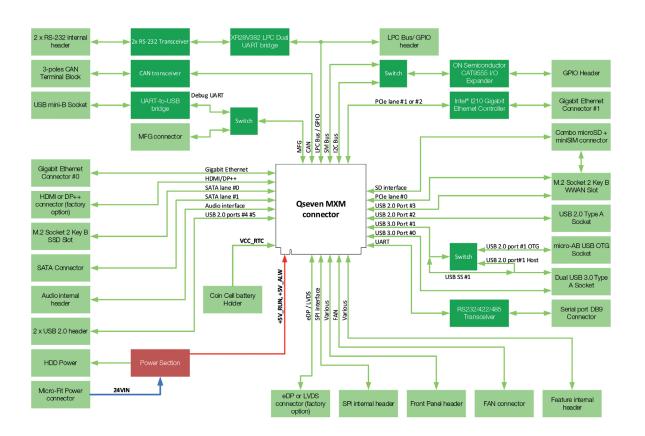
\*All carrier board components must remain within the operating temperature at any and all times, including start-up; carrier operating temperature is independent of the module installed. Please refer to the specific module for more details. Actual temperature will widely depend on application, enclosure and/or environment. Upon customer to consider specific cooling solutions for the final system.



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Carrier Board for Qseven® Rel. 2.0 / 2.1 Compliant Modules in the 3.5" Form Factor

BLOCK DIAGRAM





# Streamline and expedite your edge computing implementations

### **EDGEHOG OS**

A flexible operating system that adapts to your needs, thanks to the customization tool and Docker support. Reliability and security are built-in through a dual-partition system and native integration with Exein's robust AI-based protection.

### **DEVICE MANAGER**

PORTAL

Update, configure, and manage remote devices. Optimize time and costs to maximize operational efficiency and security without the need for costly field interventions.

### DATA ORCHESTRATION

Integrate third-party services, simplify data flows and analysis, and enhance business efficiency by enabling easy and fast utilization of AI. Analyze data from remote devices, customize the user experience with applications tailored to user needs, and manage user rights, company access, and tenant privileges.



